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FDMS2D5N08C N-Channel Shielded Gate PowerTrench[®] MOSFET 80 V, 166 A, 2.7 mΩ

Features

- Shielded Gate MOSFET Technology
- Max r_{DS(on)} = 2.7 mΩ at V_{GS} = 10 V, I_D = 68 A
- Max $r_{DS(on)}$ = 6.7 m Ω at V_{GS} = 6 V, I_D = 34 A
- 50% lower Qrr than other MOSFET suppliers
- Lowers switching noise/EMI
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

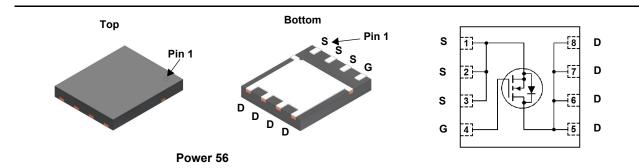


General Description

This N-Channel MV MOSFET is produced using ON Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized to minimise on-state resistance and yet maintain superior switching performance with best in class soft body diode.

Applications

- Primary DC-DC MOSFET
- Synchronous Rectifier in DC-DC and AC-DC
- Motor Drive
- Solar



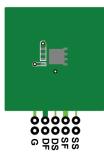
MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol		F	Ratings		Units					
V _{DS}	Drain to	Drain to Source Voltage						V		
V _{GS}	Gate to	Gate to Source Voltage						V		
ID	Drain Cu	urrent -Continuous	T _C	_c = 25 °C	(Note 5)	166				
	-Continuous			_c = 100 °C	(Note 5)	105		Α		
	-Continuous			= 25 °C	(Note 1a)	24				
	-Pulsed (Note 4)					823				
E _{AS}	Single F	Single Pulse Avalanche Energy (Note 3)				600		mJ		
P _D	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$				138		W			
	Power D	Dissipation	T _A	= 25 °C	(Note 1a)	2.7	vv			
T _J , T _{STG}	Operatir	ng and Storage Junction Te	-55 to +150		°C					
Thermal Cl						0.0				
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case					0.9		°C/W		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient(Note 1a)					45				
Package M	arking a	nd Ordering Informa	ation							
Device Marking		Device	Package	Ree	el Size	Tape Width		Quantity		
FDMS2D5N08C		FDMS2D5N08C	Power 56		13 "	12 mm	3000 units			

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	80			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		62		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 64 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			100	nA
On Chara	octeristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 380 μA	2.0	2.9	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 380 μ A, referenced to 25 °C		-8.3		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 68 A		2.2	2.7	
	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 34 A		3.3	6.7	mΩ
		V_{GS} = 10 V, I _D = 68 A, T _J = 125 °C		3.7	4.5	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 68 A		148		S
C _{iss}	Characteristics Input Capacitance Output Capacitance			4455	6240	pF
C _{oss}	Output Capacitance	-f = 1 MHz		1480	2070	pF
C _{rss}	Reverse Transfer Capacitance			59	85	pF
R _g	Gate Resistance			0.8	1.6	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			21	34	ns
t _r	Rise Time	V _{DD} = 40 V, I _D = 68 A,		11	20	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		29	47	ns
t _f	Fall Time			7	13	ns
Qg	Total Gate Charge	V_{GS} = 0 V to 10 V		60	84	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V$ $V_{DD} = 40 V$,		38	54	nC
Q _{gs}	Gate to Source Charge	I _D = 68 A		19		nC
Q _{gd}	Gate to Drain "Miller" Charge			12		nC
Q _{oss}	Output Charge	V_{DD} = 40 V, V_{GS} = 0 V		84		nC
Q _{sync}	Total Gate Charge Sync	V _{DS} = 0 V, I _D = 68 A		51		nC
Drain-Sou	urce Diode Characteristics					
N/	Source to Drain Diada, Ecourad Maltana	$V_{GS} = 0 V, I_S = 2.2 A$ (Note 2)		0.7	1.2	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 68 A$ (Note 2)		0.8	1.3	
t _{rr}	Reverse Recovery Time			30	48	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 34 A, di/dt = 300 A/μs		55	88	nC
						1

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design

 $I_F = 34 \text{ A}, \text{ di/dt} = 1000 \text{ A/}\mu\text{s}$



a. 45 °C/W when mounted on a 1 in² pad of 2 oz copper.



b. 115 °C/W when mounted on a

minimum pad of 2 oz copper.

24

139

39

222

ns

nC

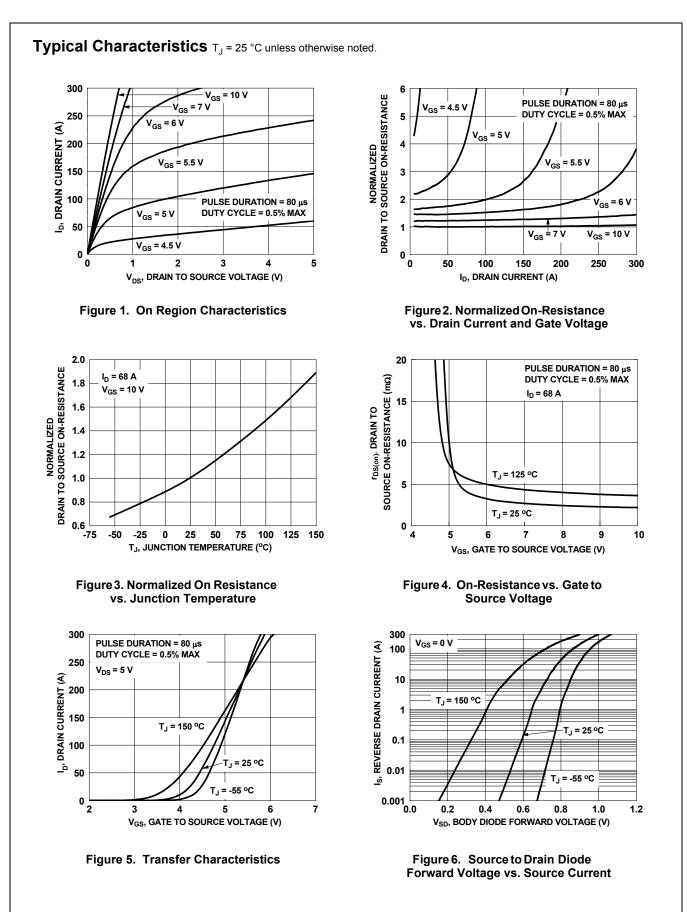
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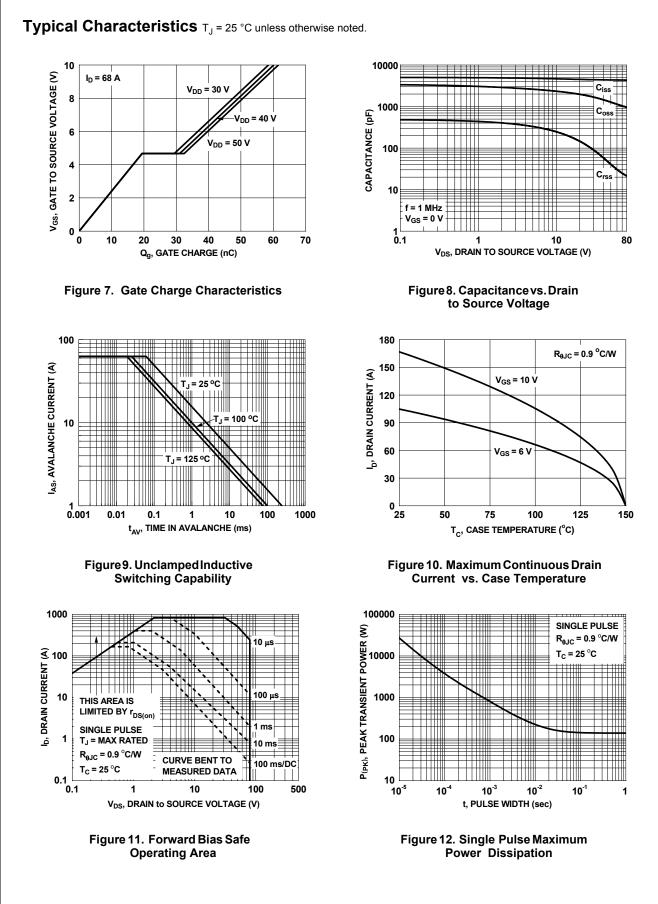
Reverse Recovery Time

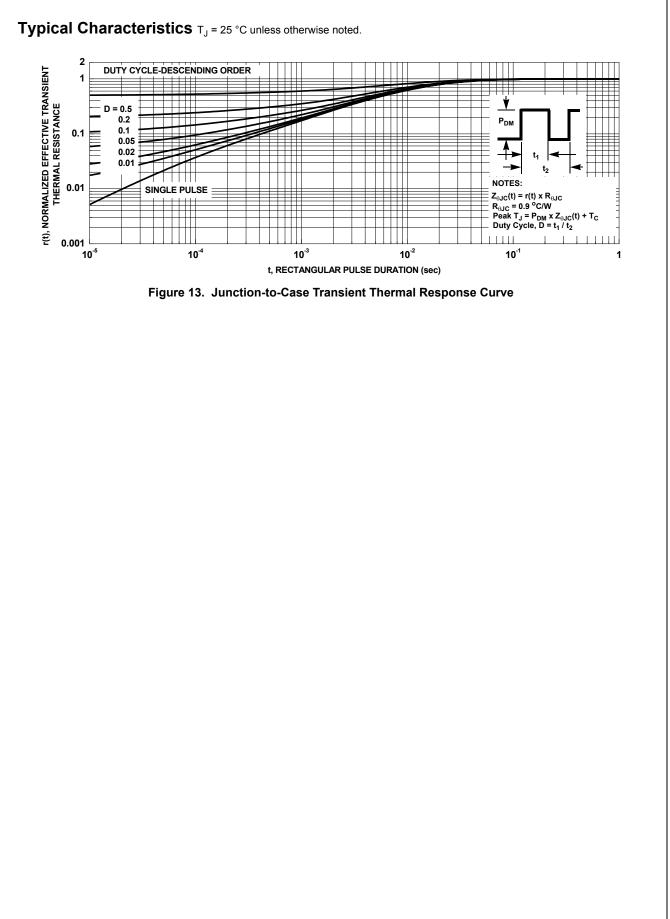
Reverse Recovery Charge

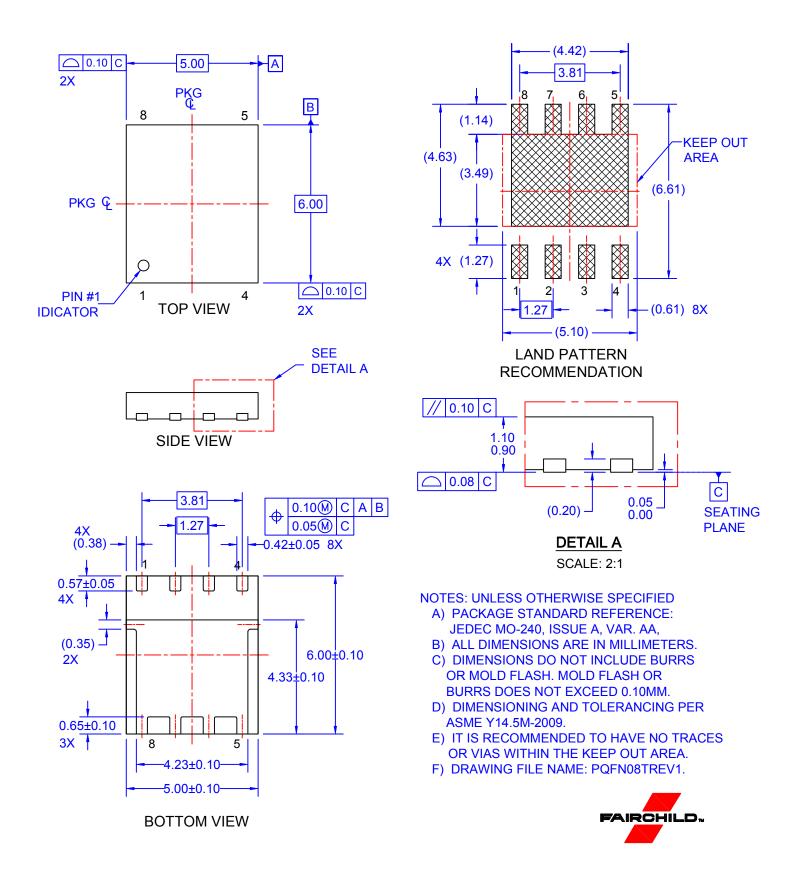
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
 E_{AS} of 600 mJ is based on starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 20 A, V_{DD} = 80 V, V_{GS} =10 V. 100% test at L = 0.1 mH, I_{AS} = 63 A.
 Pulsed Id please refer to Fig 11 SOA graph for more details.
 Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.











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